



BUK6D385-100E

100 V, N-channel Trench MOSFET

29 April 2019

Product data sheet

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a medium power DFN2020MD-6 (SOT1220) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Extended temperature range $T_j = 175\text{ °C}$
- Side wettable flanks for optical solder inspection
- ElectroStatic Discharge (ESD) protection $> 2\text{ kV HBM (class H2)}$
- Trench MOSFET technology
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- Low-side load switch
- Switching circuits

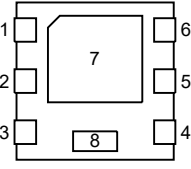
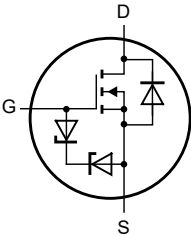
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$T_j = 25\text{ °C}$	-	-	100	V
V_{GS}	gate-source voltage		-20	-	20	V
I_D	drain current	$V_{GS} = 10\text{ V}; T_{sp} = 25\text{ °C}$	-	-	3.7	A
P_{tot}	total power dissipation	$T_{sp} = 25\text{ °C}$	-	-	15	W
Static characteristics						
R_{DSon}	drain-source on-state resistance	$V_{GS} = 10\text{ V}; I_D = 1.5\text{ A}; T_j = 25\text{ °C}$	-	280	385	m Ω

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drain	 <p>Transparent top view DFN2020MD-6 (SOT1220)</p>	 <p>017aaa255</p>
2	D	drain		
3	G	gate		
4	S	source		
5	D	drain		
6	D	drain		
7	D	drain		
8	S	source		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK6D385-100E	DFN2020MD-6	plastic, leadless thermal enhanced ultra thin small outline package; 6 terminals; 0.65 mm pitch; 2 mm x 2 mm x 0.65 mm body	SOT1220

7. Marking

Table 4. Marking codes

Type number	Marking code
BUK6D385-100E	4U

8. Limiting values

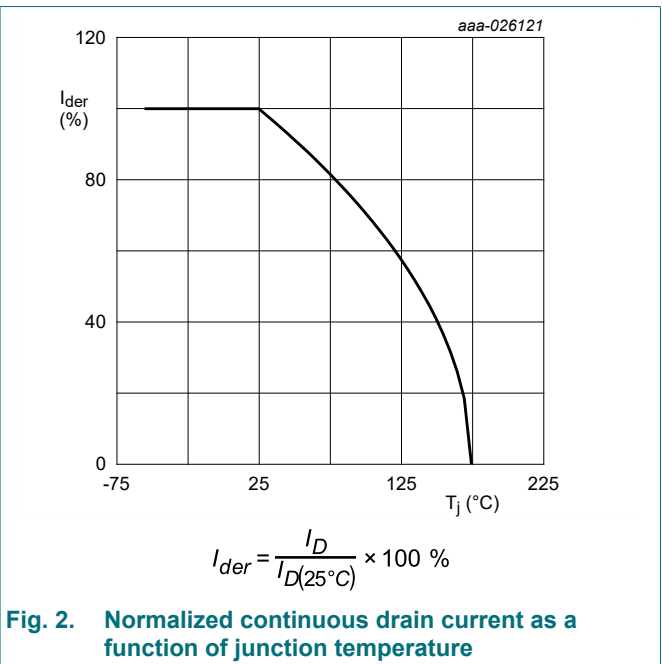
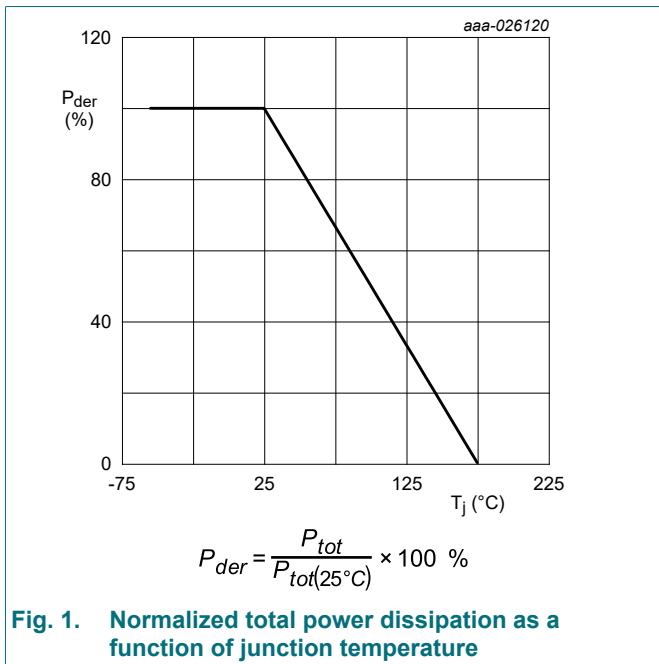
Table 5. Limiting values

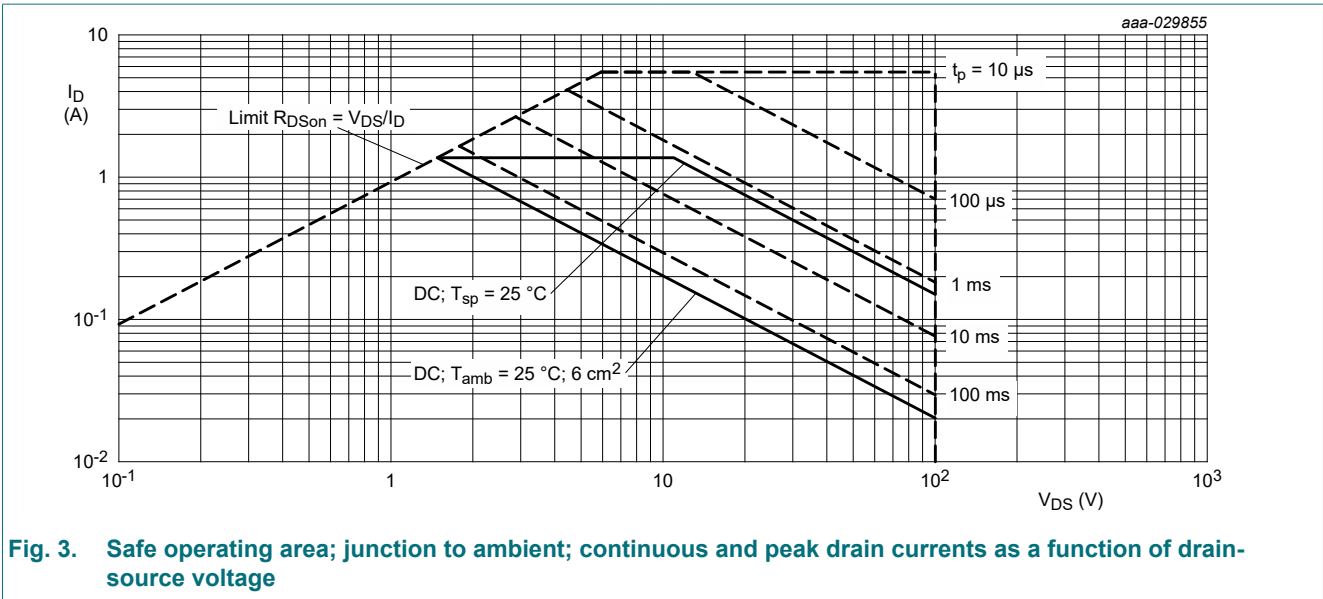
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C	-	100	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{sp} = 25 °C	-	3.7	A
		V _{GS} = 10 V; T _{sp} = 100 °C	-	2.6	A
		V _{GS} = 10 V; T _{amb} = 25 °C	[1]	1.4	A
I _{DM}	peak drain current	T _{sp} = 25 °C; single pulse; t _p ≤ 10 μs	-	15	A
P _{tot}	total power dissipation	T _{sp} = 25 °C	-	15	W
		T _{amb} = 25 °C	[1]	2	W
T _j	junction temperature		-55	175	°C
T _{amb}	ambient temperature		-55	175	°C
T _{stg}	storage temperature		-65	175	°C
Source-drain diode					
I _S	source current	T _{sp} = 25 °C	-	3.7	A
		T _{amb} = 25 °C	[1]	1.4	A
I _{SM}	peak source current	single pulse; t _p ≤ 10 μs; T _{sp} = 25 °C	-	15	A
ESD maximum rating					
V _{ESD}	electrostatic discharge voltage	HBM	[2]	2000	V
Avalanche ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	T _{j(init)} = 25 °C; I _D = 0.16 A; DUT in avalanche (unclamped)	-	8.4	mJ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

[2] Measured between all pins.





9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	67	74	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	5	10	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².

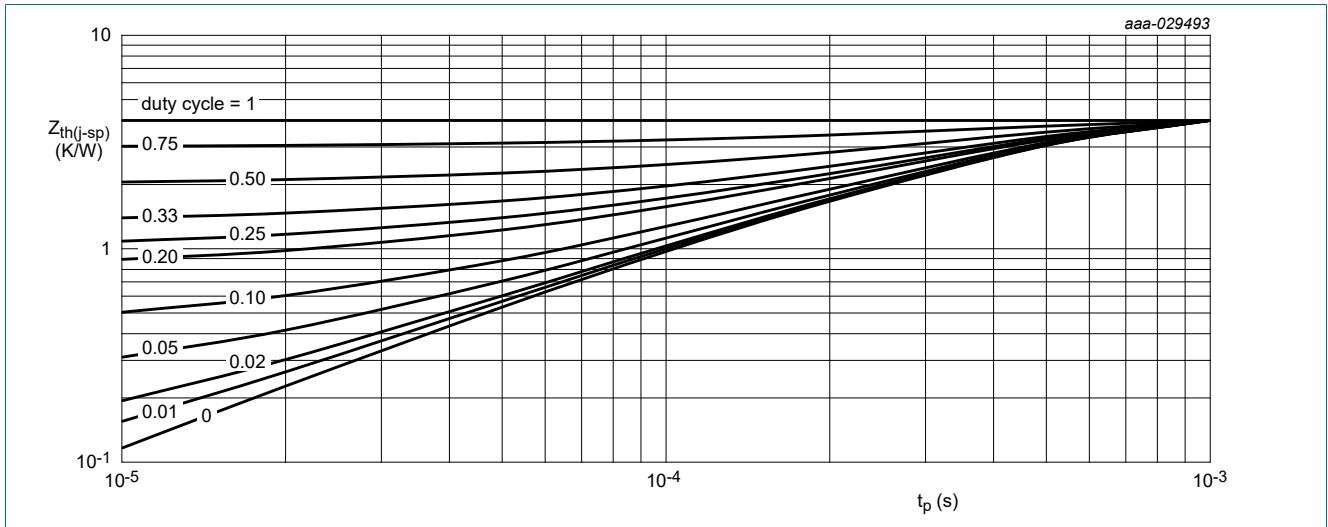


Fig. 4. Transient thermal impedance from junction to solder point as a function of pulse duration; typical values

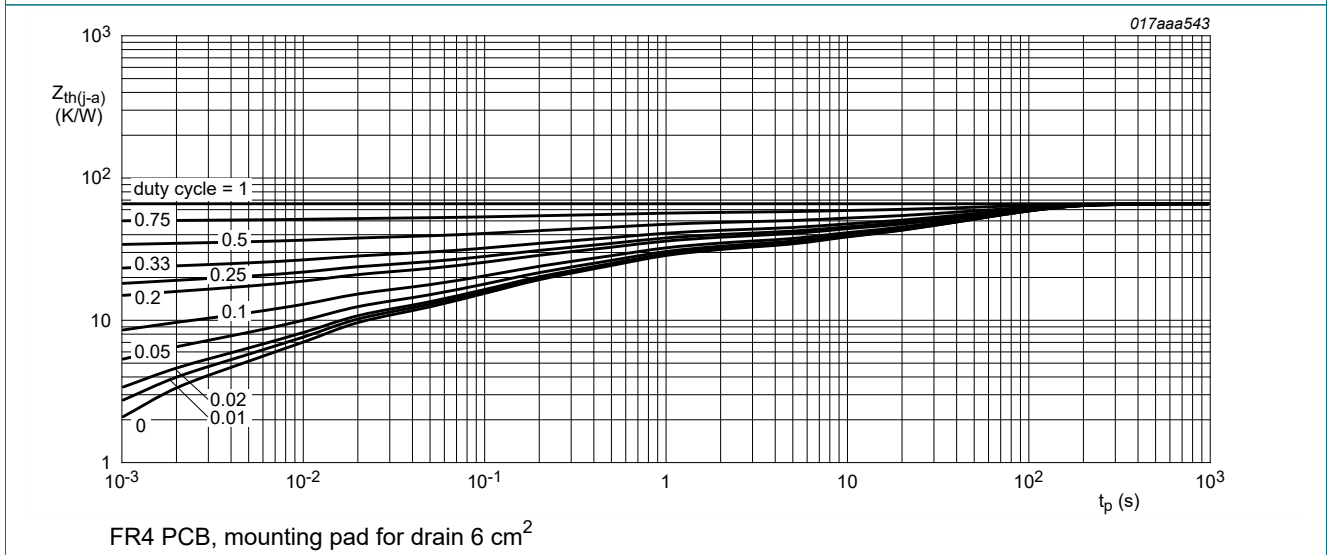


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu\text{A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	100	-	-	V
V_{GSth}	gate-source threshold voltage	$I_D = 250 \mu\text{A}$; $V_{DS} = V_{GS}$; $T_j = 25 \text{ }^\circ\text{C}$	1.3	1.7	2.7	V
I_{DSS}	drain leakage current	$V_{DS} = 100 \text{ V}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	1	μA
		$V_{DS} = 100 \text{ V}$; $V_{GS} = 0 \text{ V}$; $T_j = 125 \text{ }^\circ\text{C}$	-	-	4	μA
I_{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}$; $V_{DS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	15	μA
		$V_{GS} = -20 \text{ V}$; $V_{DS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	-15	μA
		$V_{GS} = 10 \text{ V}$; $V_{DS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	1	μA
		$V_{GS} = -10 \text{ V}$; $V_{DS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	-1	μA
R_{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}$; $I_D = 1.5 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$	-	280	385	m Ω
		$V_{GS} = 10 \text{ V}$; $I_D = 1.5 \text{ A}$; $T_j = 175 \text{ }^\circ\text{C}$	-	784	1078	m Ω
		$V_{GS} = 4.5 \text{ V}$; $I_D = 1.4 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$	-	300	432	m Ω
g_{fs}	forward transconductance	$V_{DS} = 10 \text{ V}$; $I_D = 1.5 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$	-	5.2	-	S
R_G	gate resistance	$f = 1 \text{ MHz}$	-	1.8	-	Ω
Dynamic characteristics						
$Q_{G(tot)}$	total gate charge	$V_{DS} = 50 \text{ V}$; $I_D = 1.5 \text{ A}$; $V_{GS} = 10 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	4.5	6.8	nC
Q_{GS}	gate-source charge		-	0.4	-	nC
Q_{GD}	gate-drain charge		-	1	-	nC
C_{iss}	input capacitance	$V_{DS} = 50 \text{ V}$; $f = 1 \text{ MHz}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	195	-	pF
C_{oss}	output capacitance		-	13	-	pF
C_{rss}	reverse transfer capacitance		-	9	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = 50 \text{ V}$; $I_D = 1.5 \text{ A}$; $V_{GS} = 10 \text{ V}$; $R_{G(ext)} = 6 \text{ }^\circ\Omega$; $T_j = 25 \text{ }^\circ\text{C}$	-	5	-	ns
t_r	rise time		-	7	-	ns
$t_{d(off)}$	turn-off delay time		-	9	-	ns
t_f	fall time		-	2	-	ns
Source-drain diode						
V_{SD}	source-drain voltage	$I_S = 1.4 \text{ A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	0.8	1.2	V
t_{rr}	reverse recovery time	$I_S = 1.1 \text{ A}$; $di_S/dt = -100 \text{ A}/\mu\text{s}$;	-	20	-	ns
Q_r	recovered charge	$V_{GS} = 0 \text{ V}$; $V_{DS} = 40 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$	-	11	-	nC

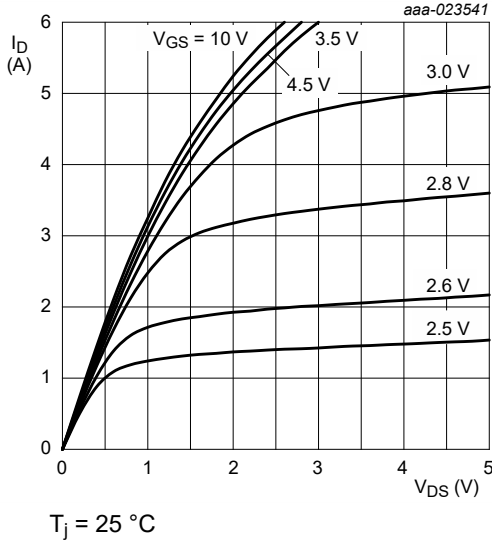


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

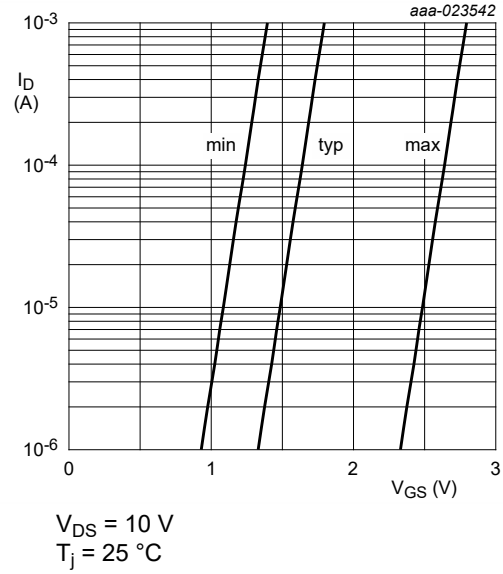


Fig. 7. Subthreshold drain current as a function of gate-source voltage

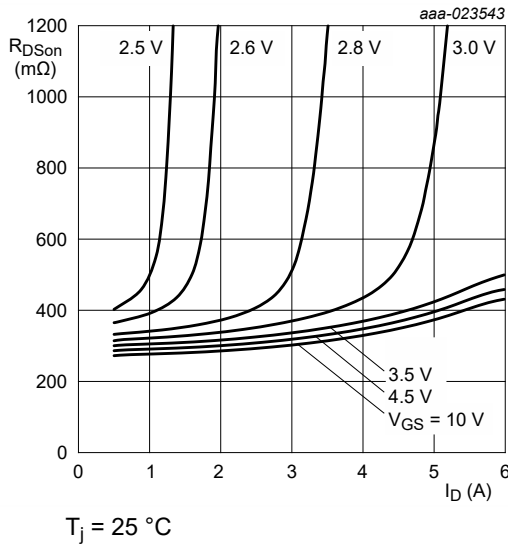


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

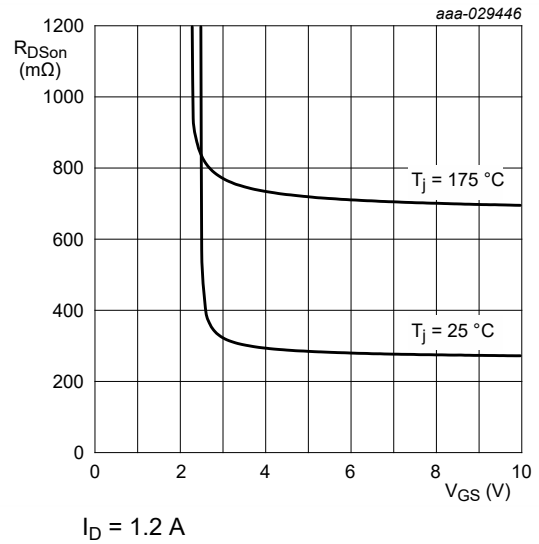
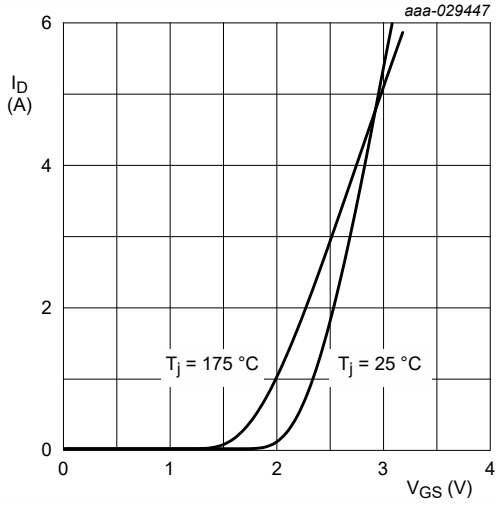
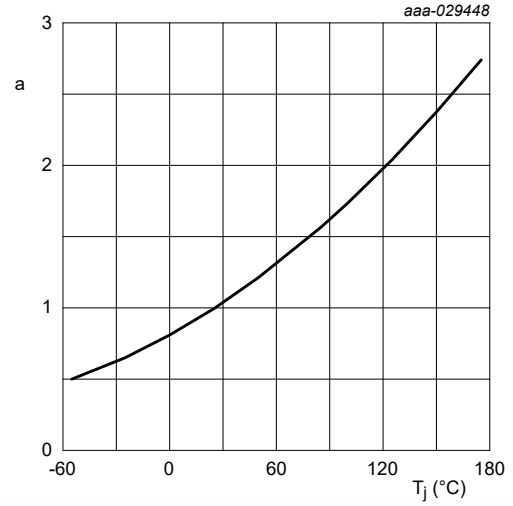


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values



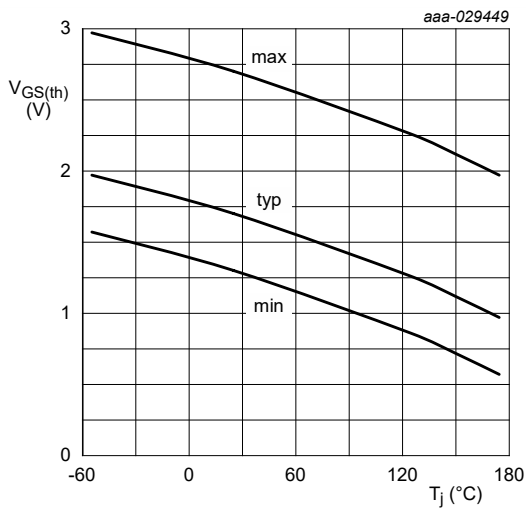
$$V_{DS} > I_D \times R_{DSon}$$

Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values



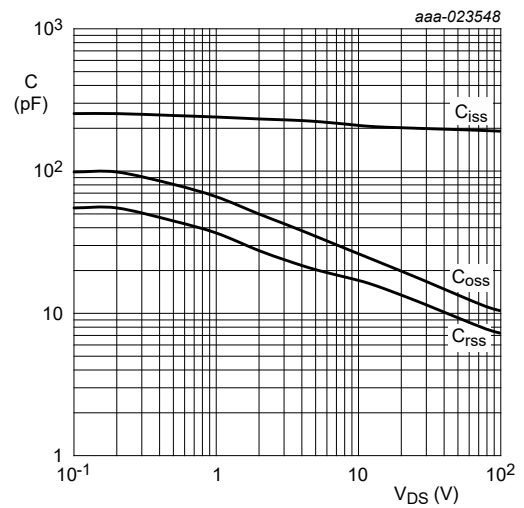
$$a = \frac{R_{DSon}}{R_{DSon}(25^\circ C)}$$

Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values



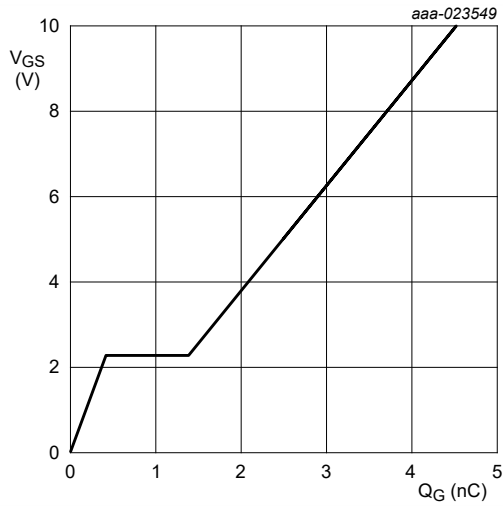
$$I_D = 250 \mu A; V_{DS} = V_{GS}$$

Fig. 12. Gate-source threshold voltage as a function of junction temperature



$$f = 1 \text{ MHz}; V_{GS} = 0 \text{ V}$$

Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$V_{DS} = 50\text{ V}; I_D = 1.5\text{ A}$

Fig. 14. Gate-source voltage as a function of gate charge; typical values

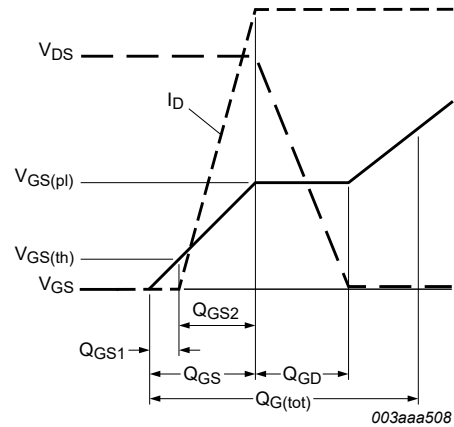
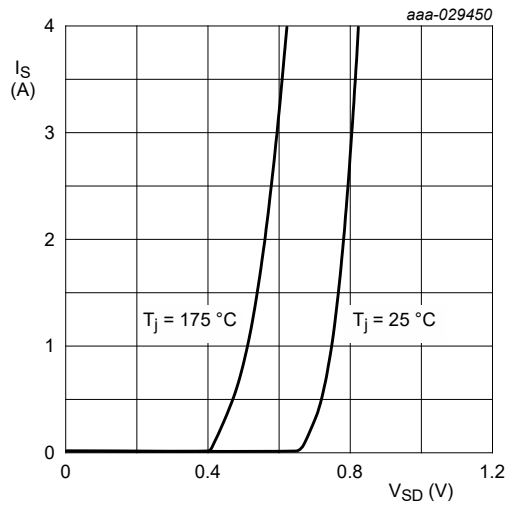


Fig. 15. Gate charge waveform definitions



$V_{GS} = 0\text{ V}$

Fig. 16. Source current as a function of source-drain voltage; typical values

11. Test information



Fig. 17. Duty cycle definition

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

DFN2020MD-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm

SOT1220

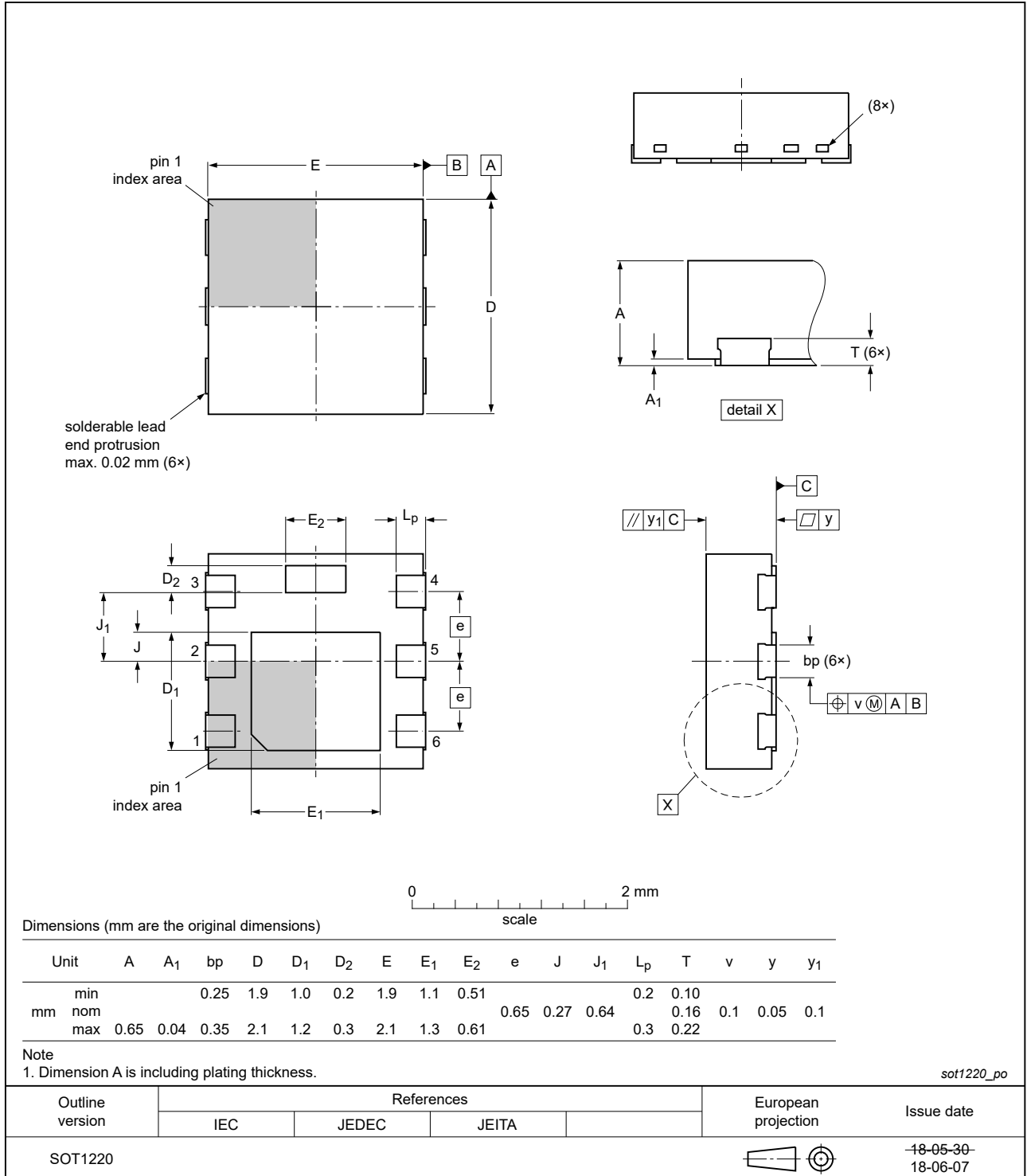


Fig. 18. Package outline DFN2020MD-6 (SOT1220)

13. Soldering



Fig. 19. Reflow soldering footprint for DFN2020MD-6 (SOT1220)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BUK6D385-100E v.1	20190429	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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